

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

By: ______ Date: <u>September 12, 2003</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

Bernd Goller et al.

Appl. No.

10/651,856

Filed

August 29, 2003

Title

Universal Semiconductor Housing with Precrosslinked Plastic

Embedding Compounds, and Method of Producing the Semiconductor

Housing

Art Unit

LETTER

Hon. Commissioner for Patents, Alexandria, VA 22313-1450

Sir:

The above-mentioned new patent application was filed on August 29, 2003 without a signed oath or declaration, under the provision of 37 C.F.R. 1.53(f).

In accordance with the above-mentioned rule, enclosed herewith is the original signed declaration.

The undersigned hereby states that the application filed in the Patent and Trademark Office is the application which the inventor(s) executed by signing the declaration. MPEP 602 (8th ed., Aug. 2001).

The fee required for the late filing of an oath or declaration in the amount of \$130.00 is also enclosed.

Respectfully submitted.

GREGORY L. MAYBACK

REØ. NØ. 40,716

/mjb

Date: September 12, 2003

Lerner and Greenberg, P.A.

Post Office Box 2480

Hollywood, FL 33022-2480 Tel: (954) 925-1100

Fax:

(954) 925-1101

09/16/2003 SSESHE1 00000107 10651856

පි

)1 FC:1051